- TL1431 Precision Programmable Reference (2.5 V) and an Optocoupler in a Single Package
- Reference Voltage Tolerance
  - TPS5904 0.8%
  - TPS5904A 0.4%
- Controlled Optocoupler CTRs:
  - TPS5904 100% to 400%
  - TPS5904A 150% to 300%
- High Withstand Voltage (WTV), 7500 V Peak for 1 Minute
- Safety Regulatory Approvals
  - UL... File Number E65085
  - FIMKO, SEMKO, NEMKO, DEMKO
    - EN60065/IEC 65
    - EN60950/IEC 950
  - VDE 0884, Level 4 (6000-V Insulation)

# LED [1° 8] NC COMP [2 7] C GND [3 6] E FB [4 5] NC

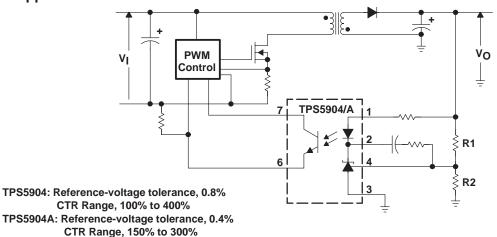
NC - No internal connection

# description

The TPS5904 and TPS5904A optoisolated feedback amplifiers consist of the industry standard TL1431 precision programmable reference and an optocoupler. Reference-voltage tolerance for the TPS5904 is 0.8%, and for the TPS5904A, 0.4%. The devices are primarily intended for use as the error-amplifier/reference/isolation-amplifier element in isolated ac-to-dc power supplies and dc/dc converters. The optocoupler is a gallium-arsenide (GaAs) light-emitting diode that emits at a wavelength of 940 nm, combined with a silicon phototransistor. The current transfer ratio (CTR) ranges from 100% to 400% in the standard version. The TPS5904A version with a 150%-to-300% CTR is available for higher-performance applications. When using the TPS5904 or TPS5904A, power-supply designers can reduce component count and save space in tightly packaged designs. The tight-tolerance reference eliminates the need for adjustments in many applications.

The TPS5904 and TPS5904A are characterized for operation from -40°C to 100°C. Each device is supplied in an 8-pin DIP or in an 8-pin gull-wing surface-mount package (DCS).

# typical application

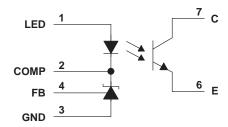




Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# functional block diagram



# **Terminal Functions**

TERM	INAL	1/0	DESCRIPTION					
NAME	NO.	٥						
С	7		Phototransistor collector					
COMP	2	0	nitting diode and TL431 cathodes					
Е	6		Phototransistor emitter					
FB	4	Ι	Feedback					
GND	3		Ground					
LED	1	Ī	Light-emitting diode anode					
NC	5, 8		No connection					

# absolute maximum ratings at 25°C free-air temperature (unless otherwise noted)†

Input power dissipation at (or below) T <sub>A</sub> = 25°C (see Note 1)	250 mW
Input LED current, I <sub>I(LED)</sub>	50 mA
Input LED voltage, $\hat{V}_{I(LED)}$	
Input diode reverse voltage	
Output power dissipation at (or below) $T_A = 25^{\circ}C$ (see Note 2)	150 mW
Output collector-to-emitter voltage	35 V
Output emitter-to-collector voltage	7 V
Output collector current	50 mA
Total continuous power dissipation at (or below) $T_A = 25^{\circ}C$ (see Note 3)	350 mW
Operating free-air temperature range, T <sub>A</sub>	40°C to 100°C
Storage temperature range, T <sub>stq</sub>	–55°C to 150°C
Total input-to-output voltage	
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Flammability	(see Note 4)

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. Derate linearly from 25°C at a rate of 2.95 mW/°C.
  - 2. Derate linearly from 25°C at a rate of 1.76 mW/°C.
  - 3. Derate linearly from 25°C at a rate of 4.12 mW/°C.
  - 4. Optocoupler total-package flame retardancy is tested to IEC695-2-2 using a flame application time of 30 seconds. Outer mold compound is verified to meet UL 94V-0.



# electrical characteristics, $T_A = 25^{\circ}C$ (unless otherwise noted)

# input

	PARAMETER		TEST COND	MIN	TYP	MAX	UNIT	
VF	Light-emitting diode forward vo	ltage	VO(COMP) = VI(FB), See Figure 1	$I_{I(LED)} = 10 \text{ mA},$		1.2	1.4	V
I <sub>R</sub>	Light-emitting diode reverse cu	rrent	V <sub>R</sub> = 6 V				10	μΑ
V <sub>ref</sub>	Reference voltage	TPS5904	$V_{O(COMP)} = V_{I(FB)},$	I <sub>I(LED)</sub> = 10 mA,	2.48	2.5	2.52	V
		TPS5904A	See Figure 1	,	2.49	2.5	2.51	
V <sub>ref(dev)</sub>	Deviation of reference voltage temperature	over	$V_O(COMP) = V_I(FB),$ $T_A = 25^{\circ}C \text{ to } 100^{\circ}C,$	I <sub>I</sub> (LED) = 10 mA, See Figure 1		25		mV
$\frac{\Delta V_{ref}}{\Delta V_{I(LED)}}$	Ratio of reference voltage char change in input light-emitting-d	•	$\Delta V_{I(LED)} = 4 \text{ V to } 37 \text{ V},$ See Figure 2	$I_{I(LED)} = 10 \text{ mA},$		-1.1	-2	mV/V
I <sub>I(FB)</sub>	Feedback input current		I <sub>I(LED)</sub> = 10 mA, See Figure 3	$R3 = 10 \text{ k}\Omega$ ,		1.5	3	μΑ
I <sub>ref(dev)</sub>	Deviation of reference input cu temperature	rrent over	I <sub>I</sub> (LED) = 10 mA, T <sub>A</sub> = 25°C to 100°C,	R3 = 10 kΩ, See Figure 3		0.5		μΑ
I <sub>DRV</sub> (min)	Minimum drive current		VO(COMP) = VI(FB),	See Figure 1		0.45	1	mA
I <sub>I(off)</sub>	Off-state input light-emitting-did	ode current	V <sub>I(LED)</sub> = 37 V, See Figure 4	$V_{I(FB)} = 0$ ,		0.18	0.5	μΑ
Z <sub>ka</sub>  †	Regulator output impedance		$V_{O(COMP)} = V_{I(FB)}$ , $I_{O(COMP)} = 1 \text{ mA to } 50 \text{ m}$	f≤1 kHz, mA		0.1		Ω

<sup>†</sup> This symbol is not currently listed within EIA or JEDEC standards for semiconductor symbology.

# output

PARAMETER		TEST C	MIN	TYP	MAX	UNIT		
ICEO	Collect dark current	V <sub>CE</sub> = 35 V,	See Figure 5			100	nA	
V(BR)ECO	Emitter-collector voltage breakdown	I <sub>E</sub> = 100 μA		7			V	

# coupler

PARAMETER			TEST CONDITIONS		MIN	TYP	MAX	UNIT
CTR	Current transfer ratio	TPS5904	VO(COMP) = VI(FB), VCE = 5 V,	I <sub>(LED)</sub> = 5 mA, See Figure 6	100%		400%	
		TPS5904A			150%		300%	
VCE(sat)	Collector-emitter saturation volta	VO(COMP) = VI(FB), IC = 1  mA,	I <sub>I(LED)</sub> = 10 mA, See Figure 6		0.1	0.2	V	
v <sub>iso</sub> †	Isolation voltage		$I_{IO} = 10 \mu\text{A}, \qquad f = 60 \text{Hz}$	Z	7500			V
Cio	Input to output capacitance		$V_{IO} = 0$ , $f = 1 \text{ kHz}$	<u>z</u>		0.6		pF

<sup>†</sup> This symbol is not currently listed within EIA or JEDEC standards for semiconductor symbology.



# PARAMETER MEASUREMENT INFORMATION

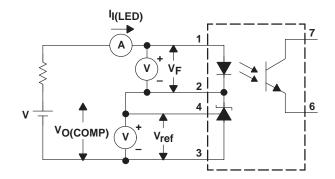


Figure 1.  $V_{ref}$ ,  $V_{F}$ ,  $I_{min}$  Test Circuit

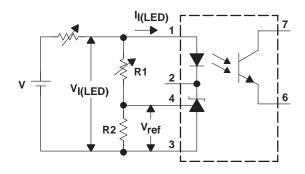


Figure 2.  $\Delta V_{ref}/\Delta V_{I(LED)}$  Test Circuit

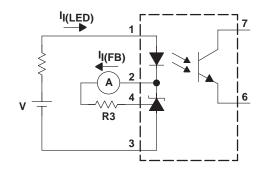


Figure 3. I<sub>I(FB)</sub> Test Circuit

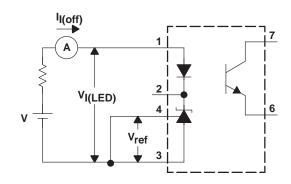


Figure 4. I<sub>I(off)</sub> Test Circuit

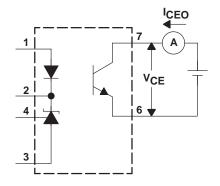


Figure 5. I<sub>CEO</sub> Test Circuit

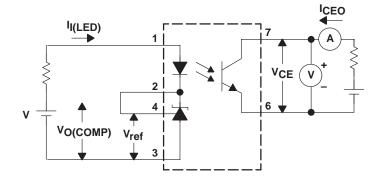
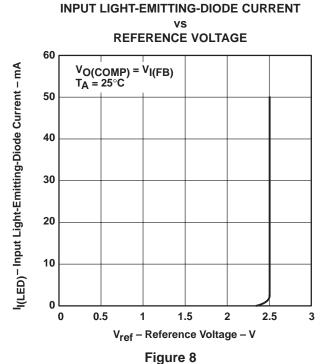


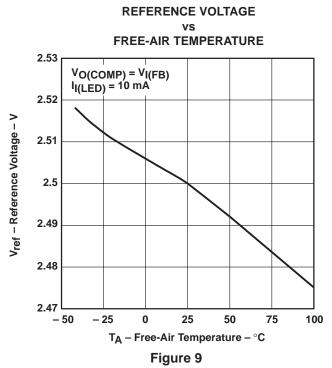
Figure 6. CTR, V<sub>CE(sat)</sub> Test Circuit

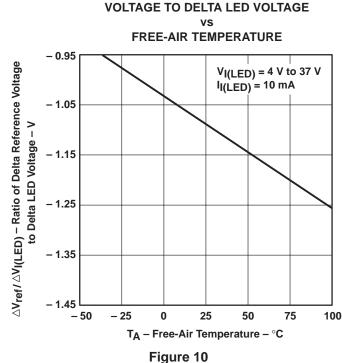
#### **TYPICAL CHARACTERISTICS**

# INPUT LIGHT-EMITTING-DIODE CURRENT **REFERENCE VOLTAGE** 1400 $I_{I}(LED)^-$ Input Light-Emitting-Diode Current – $\mu A$ $V_{O(COMP)} = V_{I(FB)}$ T<sub>A</sub> = 25°C 1200 800 600 400 200 0 0 0.5 1.5 2.5 3 V<sub>ref</sub> - Reference Voltage - V

Figure 7







**RATIO OF DELTA REFERENCE** 

#### TYPICAL CHARACTERISTICS

# REFERENCE CURRENT FREE-AIR TEMPERATURE 2.5 $I_{\text{I(LED)}} = 10 \text{ mA}$ R3 = 10 k $\Omega$ 2 I - Reference Current - μΑ 1.5 0.5 - 25 25 50 75 100 TA - Free-Air Temperature - °C

**OFF-STATE INPUT** LIGHT-EMITTING-DIODE CURRENT

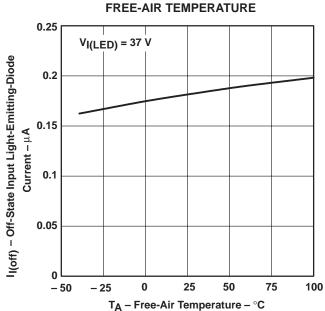
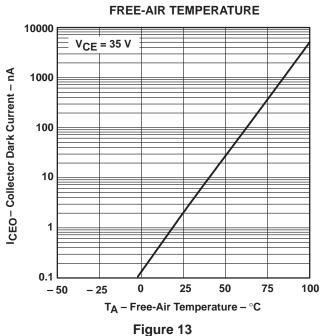


Figure 12

# **COLLECTOR DARK CURRENT**

Figure 11



# NORMALIZED CURRENT TRANSFER RATIO RELATIVE TO VALUE AT $T_A = 25^{\circ}C$ FREE-AIR TEMPERATURE 1.2

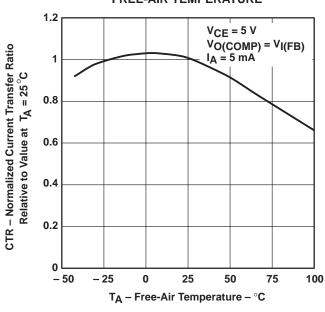
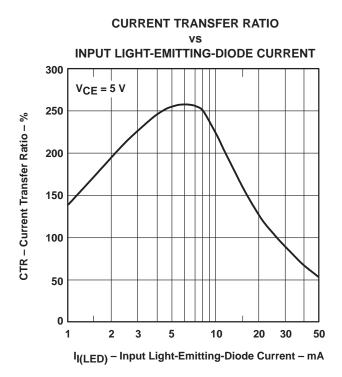


Figure 14

**COLLECTOR-TO-EMITTER SATURATION VOLTAGE** 

#### TYPICAL CHARACTERISTICS



# VS FREE-AIR TEMPERATURE > 0.20 | Il(LED) = 10 mA | IC = 1 mA | | IC = 1 mA | | O.14 | | O.10 | | O.10 | | O.10 | | O.08 | | O.10 | | O.08 | | O.08

Figure 15

Figure 16

 $T_A$  – Free-Air Temperature –  $^{\circ}$ C

# INPUT LIGHT-EMITTING-DIODE FORWARD CURRENT

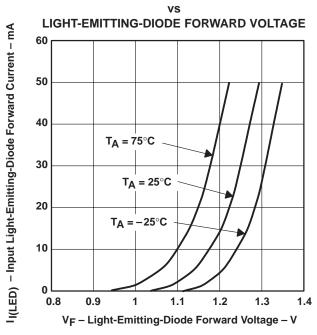
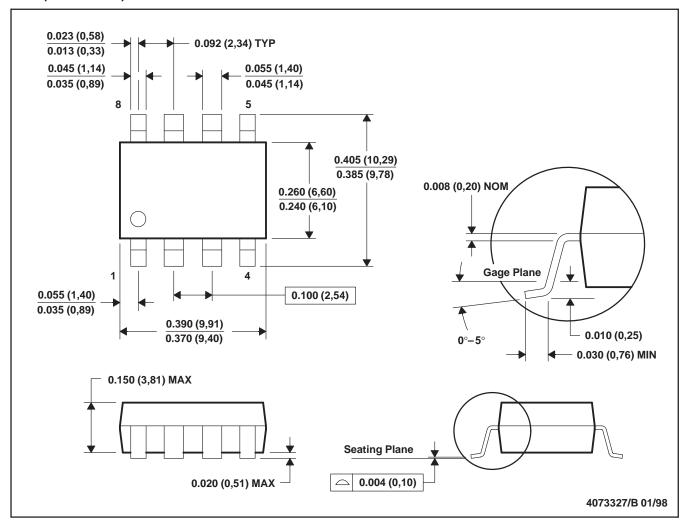


Figure 17

# **MECHANICAL DATA**

# DCS (R-PDSO-G8)

# PLASTIC DUAL SMALL-OUTLINE OPTO COUPLER



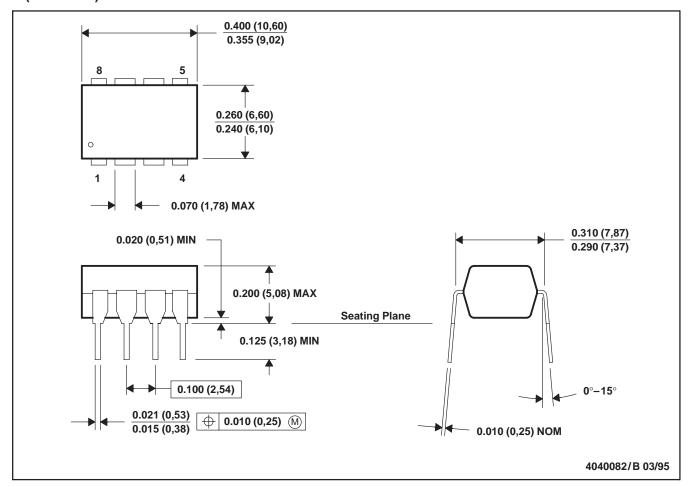
 $\label{eq:NOTES:A.All linear dimensions are in inches (millimeters).}$ 

B. This drawing is subject to change without notice.

# **MECHANICAL DATA**

# P (R-PDIP-T8)

# PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

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